Addendum

HC908JB16AD/D Rev. 1, 8/2002

Addendum to MC68HC908JB16 Technical Data





This addendum provides update and additional information to the MC68HC908JB16 Technical Data, Rev. 1 (Motorola document number MC68HC908JB16/D),

pertaining to the following:

- MC68HC908JB16
 - Update to V_{REG} LVI trip point
 - 20-pin SOIC package
- MC68HC908JB12
- MC68HC08JB16

MC68HC908JB16

This section updates data sheet information and introduces the 20-pin SOIC package for the MC68HC908JB16.

V_{REG} LVI Trip Point

Page 318, entry for minimum $V_{\mbox{\scriptsize REG}}$ LVI trip point voltage has been updated.

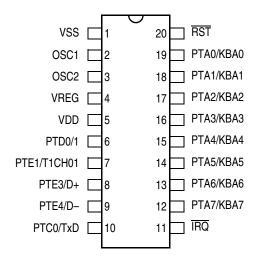
From:

Characteristic	Symbol	Min	Тур	Max	Unit
V _{REG} LVI trip point voltage	V_{LVR}	2.0	2.2	2.6	V

To:

V _{REG} LVI trip point voltage	V _{LVR} 1.9	2.2	2.6	V
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20-Pin SOIC Order Number: MC68HC908JB16JDW

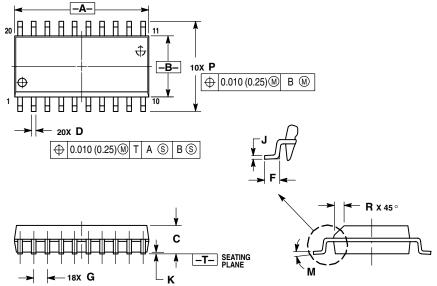


Pins not available on 20-pin package:			
PTE0/TCLK	PTD2		
PTE2/T2CH01	PTD3		
CGMXFC2	PTD4		
CGMOUT2	PTD5		
VREGA1			
VSSA1	VDDA		
	PTE0/TCLK PTE2/T2CH01 CGMXFC2 CGMOUT2 VREGA1		

Internal pads are unconnected.

PTD0/1 pin: PTD0 and PTD1 internal pads are bonded together to PTD0/1 pin, and has 50 mA sink capability when configured as an output. Pin direction must be configured such that DDRD0 = DDRD1.

Figure 1. 20-Pin SOIC Pin Assignment



- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS A AND B DO NOT INCLUDE
- MOLD PROTRUSION.

 4. MAXIMUM MOLD PROTRUSION 0.150
- 4. MAXIMUM MOLD PHO I HUSION 0.150 (0.006) PER SIDE.

 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.13 (0.005) TOTAL IN EXCESS OF D DIMENSION. AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	12.65	12.95	0.499	0.510
В	7.40	7.60	0.292	0.299
С	2.35	2.65	0.093	0.104
D	0.35	0.49	0.014	0.019
F	0.50	0.90	0.020	0.035
G	1.27 BSC		0.050	BSC
J	0.25	0.32	0.010	0.012
K	0.10	0.25	0.004	0.009
M	0 °	7°	0°	7°
Р	10.05	10.55	0.395	0.415
R	0.25	0.75	0.010	0.029

Figure 2. 20-Pin SOIC Mechanical Dimensions (Case No. 751D)

MC68HC908JB12

This section introduces the MC68HC908JB12, a derivative of the MC68HC908JB16. The entire MC68HC908JB16 data book, including the updates in this addendum, applies to this device, with exceptions outlined below.

Table 1. Summary of MC68HC908JB12 and MC68HC908JB16 Differences

	MC68HC908JB12	MC68HC908JB16
FLASH Memory	12,288 bytes (\$CA00–\$F9FF)	16,384 bytes (\$BA00–\$F9FF)
Dual Clock Generator Module	Not implemented. \$0051–\$0059 unimplemented.	Available in 32-pin LQFP only.
Available Packages ⁽¹⁾	— 28-pin SOIC 20-pin SOIC	32-pin LQFP 28-pin SOIC 20-pin SOIC

Notes:

MCU Block Diagram Figure 3 shows the structure of the MC68HC908JB12.

Memory Map Figure 4 shows the memory map of the MC68HC908JB12.

Dual Clock Generator Module

The dual 27-MHz clock generator module on the MC68HC908JB16 is not designed in the MC68HC908JB12, hence, register locations from \$0051 to \$0059 are unimplemented. Information in the data book relating to the CGM do

not apply to the MC68HC908JB12.

^{1.} The pin assignments are identical for both devices; see data sheet.

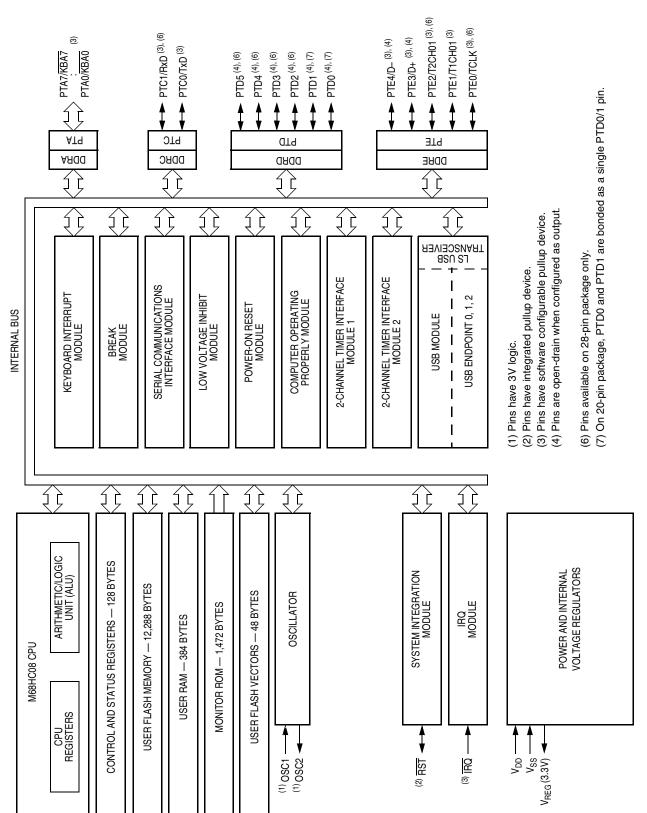


Figure 3. MC68HC908JB12 Block Diagram

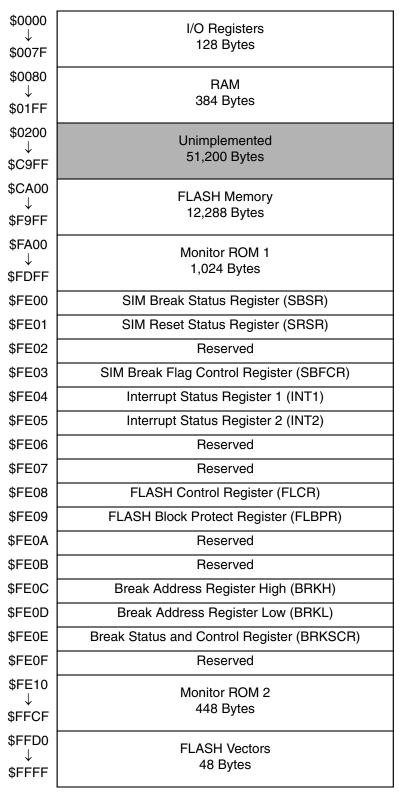


Figure 4. MC68HC908JB12 Memory Map

Pullup on PTE3/D+ and PTE4/D- Pins

On the MC68HC908JB12, control over the pullup devices on PTE3/D+ and PTE4/D- pins are shown in **Table 2**.

Table 2. Pullup Control on PTE3/D+ and PTE4/D- Pins

PULLEN (\$001A)	USBEN (\$0038)	PTExP (\$001D)	PTE4IE (\$001C)	PTE3/D+ pin	PTE4/D- pin
0	0	0	0	_	_
0	0	1	0	5 k Ω pullup to V _{DD}	5 k Ω pullup to V _{DD}
0	0	0	1	_	5 k Ω pullup to V _{DD} $^{(1)}$
0	0	1	1	5 k Ω pullup to V_{DD}	5 k Ω pullup to V _{DD} ⁽¹⁾
0	1	X	Х	_	_
1	1	Х	Х	_	1.5kΩ pullup to V _{REG}
1	0	Х	0	_	1.5kΩ pullup to V_{REG}
1	0	Х	1	Do not set this	configuration.

Notes:

1. External interrupt function is also enabled on PTE4/D- pin.

Electrical Specifications

Electrical specifications for the MC68HC908JB16 apply to the MC68HC908JB12, except for the USB reset timing:

Bus State Transmit		Signaling Levels	
		Receive	
Reset	NA	D+ and D- < V_{IL} (max) for $\geq 8\mu s$ (MC68HC908JB16) D+ and D- < V_{IL} (max) for $\geq 125\mu s$ (MC68HC908JB12)	

Order Numbers

These are MC order numbers for MC68HC908JB12.

Table 3. MC68HC908JB12 Order Numbers

MC Order Number	Package	Operating Temperature Range
MC68HC908JB12JDW	20-pin SOIC	0 °C to +70 °C
MC68HC908JB12DW	28-pin SOIC	0 °C to +70 °C

MC68HC08JB16

This section introduces the MC68HC08JB16, the ROM part equivalent to the MC68HC908JB16. The entire MC68HC908JB16 data book applies to this ROM device, with exceptions outlined below.

Table 4. Summary of MC68HC08JB16 and MC68HC908JB16 Differences

	MC68HC08JB16	MC68HC908JB16	
Memory (\$BA00-\$F9FF)	16,384 bytes ROM	16,384 bytes FLASH	
User vectors (\$FFD0-\$FFFF)	48 bytes ROM	48 bytes FLASH	
Registers at \$FE08 and \$FE09	Not used; locations are reserved	FLASH related registers. \$FE08 — FLCR \$FE09 — FLBPR	
Monitor ROM 1 (\$FA00-\$FDFF)	Unimplemented	Used for testing and FLASH	
Monitor ROM 2 (\$FE10-\$FFCF)	Used for testing purposes only.	programming/erasing.	
Dual Clock Generator Module	Currently not available.	Available in 32-pin LQFP only.	
Available Packages ⁽¹⁾	32-pin LQFP currently not available. 28-pin SOIC 20-pin SOIC	32-pin LQFP 28-pin SOIC 20-pin SOIC	

Notes:

MCU Block Diagram Figure 5 shows the block diagram of the MC68HC08JB16.

Memory Map Figure 6 shows the memory map of the MC68HC08JB16.

Reserved Registers The two registers at \$FE08 and \$FF09 are reserved locations on the

MC68HC08JB16.

On the MC68HC908JB16, these two locations are the FLASH control register

and the FLASH block protect register respectively.

Monitor ROM The monitor program (monitor ROM, \$FE10-\$FFCF) on the MC68HC08JB16

is for device testing only.

^{1.} The pin assignments are identical for both devices; see data sheet.

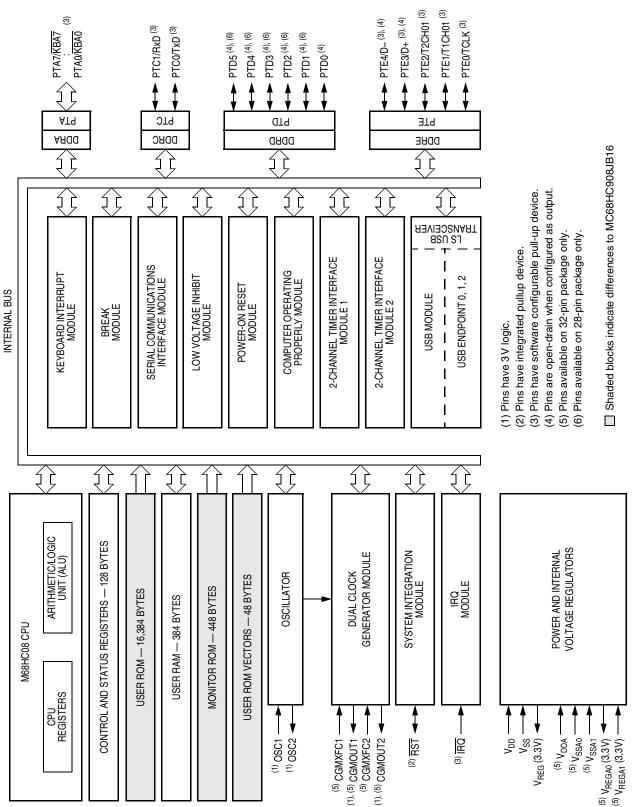


Figure 5. MC68HC08JB16 Block Diagram

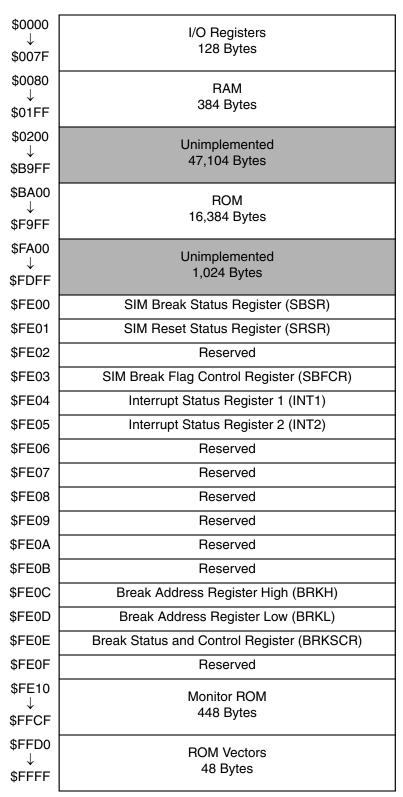


Figure 6. MC68HC08JB16 Memory Map

HC908JB16AD/D

Electrical Specifications

Electrical specifications for the MC68HC908JB16 apply to the

MC68HC08JB16, except for the following:

FLASH Memory Characteristics The FLASH memory electrical characteristics do not apply to the

MC68HC08JB16 ROM device.

ROM MC Order Numbers These part numbers are generic numbers only. To place an order, ROM code must be submitted to the ROM Processing Center (RPC).

Table 5. ROM MC Order Numbers

MC Order Number	Package	Operating Temperature Range
MC68HC08JB16JDW	20-pin SOIC	0 °C to +70 °C
MC68HC08JB16DW	28-pin SOIC	0 °C to +70 °C

HC908JB16AD/D NOTES

reescale Semiconductor, Inc.

NOTES

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